

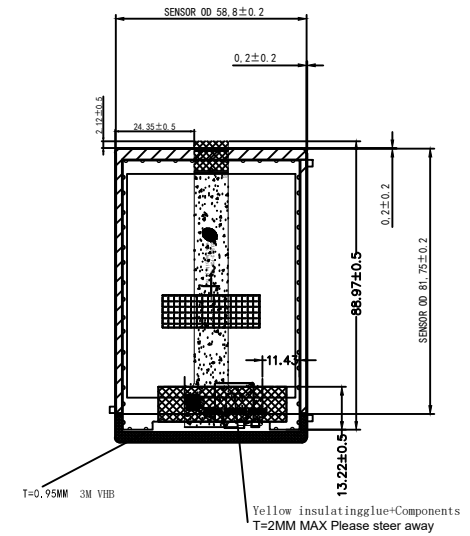
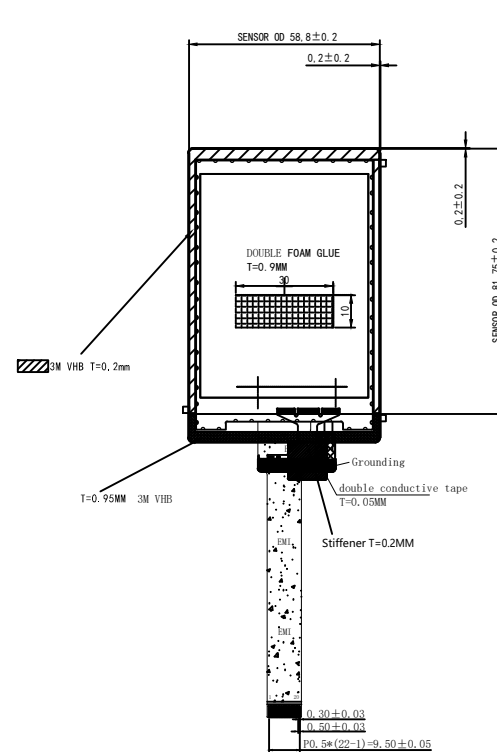
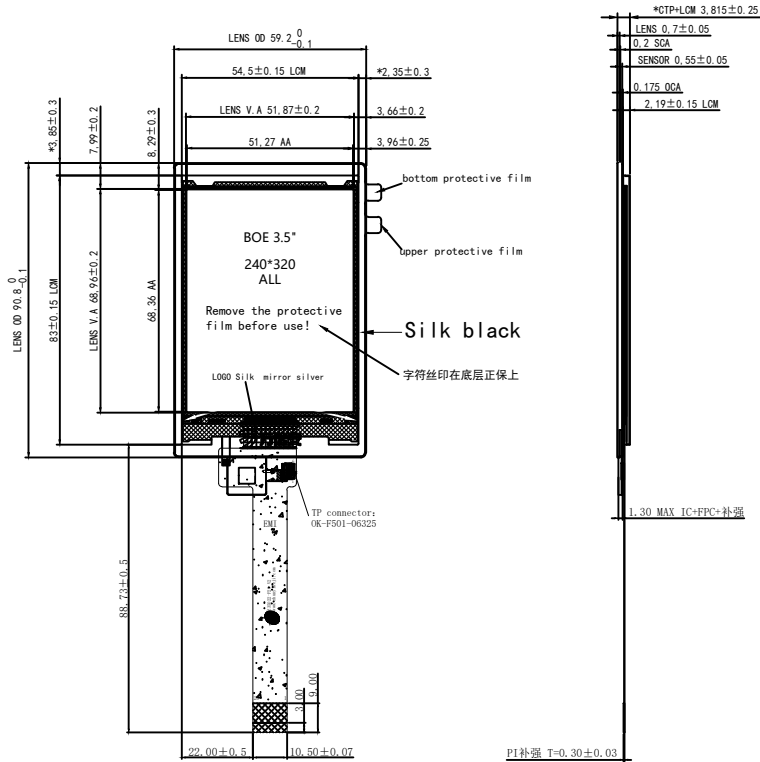
受控文件

FRONT VIEW

SIDE VIEW

BACK VIEW

FPC BENDING DIAGRAM



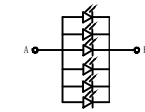
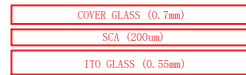
LCM:4spi

NO.	PIN NAME
1	TE
2	LEDK
3	LEDK
4	LEDA
5	LEDA
6	GND
7	RESET
8	CS
9	SCL
10	RS
11	SDA
12	GND
13	VCC
14	GND
15	TP_VDD
16	TP_SCL
17	TP_SDA
18	TP_INT
19	TP_RST
20	GND

PIN	DESCRIPTION
1	VDD2.8
2	CTP_SCL
3	CTP_SDA
4	CTP_INT
5	CTP_RST
6	GND

Technical Specification	
1	Product structure type
2	Strength method
3	Cover lens surface hardness
4	Transmittance without ink
5	Operation temperature
6	Storage temperature
7	Surface AR process requirements
8	Surface AG process requirements
9	Surface AR process requirements
10	Surface ink dye value
11	Surface integrated black effect
12	TP disappear
13	Bonding position dispensing protection
14	Impact parameters of falling ball: 64g steel ball in 50cm height drop, central point 3 frequency breakage-free.
Interface	IC
Touch driver IC	CST8922
Y/D	2.8V-3.3V
Resistance of SDASCL on main-board	YES
Display/Touch Luminance	300 cd/m2 TYP
Unmarked tolerance	±0.20mm
Mark *	as the key control size
All materials	comply with ROHS & REACH requirement*

Main Structure



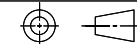
LED CIRCUIT DIAGRAM:
IF=120mA, VF=2.8-3.3V

note:
LCM FPC Bending shipping
TP FPC Bending shipping



Shenzhen Zhunyi Technology Co.,Ltd

UNIT:mm



Drawn By

Checked By

Approved By

DECRIPION

ZC

PART NO.

Z35022-P20-ZC2

DRAWING NO.

shi jin

SYH

Change the LCM FPC structure

2024.05.06

shijin

1ST

2024.04.07

shijin

REVISED DESCRIPTION

DATE

NAME